

COVER SHEET

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I	N	C	.																										

(Company's Full Name)

N	O	R	T	H		S	C	I	E	N	C	E		A	V	E	.			L	A	G	U	N	A				
T	E	C	H	N	O	P	A	R	K	,		B	I	N	A	N	,		L	A	G	U	N	A					

(Business Address: No. Street City / Town / Province)

Laurice S. Dela Cruz

Contact Person

7756-6840

Company Telephone Number

1	2
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Month

3	1
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Day

Fiscal Year

SEC FORM 17-C

FORM TYPE

0	4
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Month

1	5
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Day

Annual Meeting

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Secondary License Type, if Applicable

C	F	D
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Dept. Requiring this Doc.

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Amended Articles Number/Section

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Total No. Of Stockholders

Total Amount of Borrowings

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Domestic

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Foreign

To be accomplished by SEC Personnel concerned

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File Number

LCU

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Document I.D.

Cashier

STAMPS

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SECURITIES AND EXCHANGE COMMISSION

SEC FORM 17-C

CURRENT REPORT UNDER SECTION 17 OF THE SECURITIES REGULATIONS CODE (SRC) AND SRC RULE 17(a)-1(b)(3) THEREUNDER

1. January 24, 2025
Date of Report (Date of earliest event reported)
2. 94419
SEC Identification Number
3. 000-409-747-000
BIR Tax Identification Number
4. INTEGRATED MICRO-ELECTRONICS, INC.
Exact Name of registrant as specified in its charter
5. PHILIPPINES
Province, country or other jurisdiction of incorporation
6. [REDACTED] (SEC Use Only)
Industry Classification Code
7. North Science Avenue, Laguna Technopark-Special Processing Zone, Binan, Laguna
Address of principal office
- 4024
Postal code
8. (632) 7756-6840
Registrant's telephone number, including area code
9. Not Applicable
Former name or former address, if changed since last report
10. Securities registered pursuant to Sections 4 and 8 of the SRC

Title of Each Class	Number of Shares of Common Stock Outstanding and Amount of Debt Outstanding
<u>COMMON (net of Treasury Shares)</u>	<u>2,217,293,215</u>

11. Indicate the item numbers reported herein : Item 9 (Other Events)

Re: **Press Release: Integrated Micro-Electronics, Inc. Announces Strategic Closure of Chengdu Facility to Optimize Operations**

Pursuant to the requirements of the Securities Regulations Code, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

INTEGRATED MICRO-ELECTRONICS, INC.

Registrant

Date : January 24, 2025

ROBERT WILLIAM HEESE

Chief Finance Officer and Compliance Officer
Signature and Title*

* Print name and title of the signing officer under the signature.



Integrated Micro-Electronics, Inc.
North Science Avenue,
Special Export Processing Zone
Laguna Technopark
Binan Laguna 4024
Philippines

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Tel +63 49 544 0312
www.global-imi.com

January 24, 2025

Securities and Exchange Commission

SEC Headquarters, 7907 Makati Avenue
Salcedo Village, Brgy. Bel-Air, Makati City 1209

Attention: Atty. Oliver O. Leonardo
Director, Markets and Securities Regulation Department

The Philippine Stock Exchange

PSE Tower, 5th Avenue corner 28th Street
Bonifacio Global City
Taguig City 1634

Attention: Atty. Stefanie Ann B. Go
Officer-in-Charge, Disclosure Department

Mesdames/Gentlemen:

Please be informed that Integrated Micro-Electronics, Inc. disclosed a press release regarding the strategic closure of its Chengdu facility to optimize operations.

Please refer to the attached press release.

Very truly yours,

ROBERT WILLIAM HEESE
Chief Finance Officer and Compliance Officer



Integrated Micro-Electronics, Inc. Announces Strategic Closure of Chengdu Facility to Optimize Operations

January 24, 2025, Biñan, Laguna, Philippines – Integrated Micro-Electronics, Inc. (IMI), a leading provider of electronics manufacturing services, announces the strategic closure of its Chengdu, China facility. This move is part of IMI's ongoing efforts to streamline operations and reduce costs, aligning with the company's strategy to consolidate its footprint into strategically located facilities.

Production at IMI Chengdu concluded in December 2024, with all customer commitments successfully met. The remaining customer projects have been seamlessly transferred to other IMI sites.

As part of the closure process, IMI will complete the transfer of assets and equipment by the end of January 2025. The facility is scheduled to be formally handed back to the landlord by February 2025. Additionally, IMI is working diligently to comply with local government regulations, initiating a six-month winding up period starting in February 2025.

This strategic move is expected to enhance operational efficiency and bolster IMI's capability to deliver high-quality products and services to its global portfolio of customers from its other strategically positioned manufacturing sites.

"We are taking these steps to ensure our operations remain aligned with market demands while enhancing our ability to serve customers with agility and cost-effectiveness. We extend our heartfelt gratitude to our Chengdu team for their dedication and hard work in ensuring a smooth transition," said Louie Hughes, CEO of IMI.

About IMI

Integrated Micro-Electronics, Inc. (IMI), is a leading global electronics manufacturing solutions expert specializing in highly reliable and quality electronics for long product life cycle segments in the automotive, industrial, power electronics, communications, and medical industries.

IMI ranks among the top EMS providers in the world by the Manufacturing Market Insider, based on 2023 revenues and remains among the top ten in the automotive sector according to New Venture Research.

From its 19 manufacturing plants across nine different countries, the company provides engineering, manufacturing, and support and fulfillment capabilities to diverse industries globally.

For more information, visit www.global-imi.com.